

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**In re application of**  
**K. OKAJIMA, et al.**

**Serial No.: To Be Assigned**

**Art Unit: To Be Assigned**

**Filed: Concurrently Herewith**

**Examiner: To Be Assigned**

**For: Method For Forming Solder-Resist Film**

**TRANSMITTAL**

Honorable Commissioner of  
Patents and Trademarks  
Washington, D.C. 20231

Sir:

In accordance with the provisions of 37 CFR 1.55 and the requirements of 35 U.S.C. 119, attached hereto is a certified copy of the priority application, Japanese Patent Application No. 2002-224827 filed August 1, 2002 .

It is respectfully requested that applicant be granted the benefit of the filing date of the foreign application and that receipt of this priority document be acknowledged in due course.

Respectfully submitted,

TOWNSEND & BANTA



Donald E. Townsend  
Reg. No. 22,069

Date: July 31, 2003

TOWNSEND & BANTA  
601 Pennsylvania Ave., N.W.  
Suite 900, South Building  
Washington, D.C. 20004  
(202) 220-3124

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**  
**PATENT APPLICATION TRANSMITTAL LETTER**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Transmitted herewith for filing pursuant to 37 C.F.R. 1.53 is the patent application of:

**INVENTORS:**

Keiichi OKAJIMA  
1-10-22-704 Chuo, Joto-ku, Osaka-city,  
Osaka 536-0005, Japan

Hiroshi ODA  
7-2-301, Asahigaoka, Toyonaka-city,  
Osaka 561-0085, Japan

Takahiro NAKANO  
1-43-918, Shimeien, Ibaraki-city,  
Osaka 567-0043, Japan

**FOR: Method For Forming Solder-Resist Film**

Enclosed are:

(3) three sheets of drawings.  
 An Assignment of the invention to: Nippon Paint Co., Ltd.  
 An associate power of attorney.  
 A Notice of Informal Filing of New Patent Application.

22241 U.S. PTO  
10/630858  
07/31/03



17648  
07/31/03  
U.S. PRO

The filing fee is calculated as follows:

	CLAIMS AS	FILED	SMALL ENTITY		OTHER THAN A SMALL ENTITY
FOR	NO. FILED	NO. EXTRA	RATE FEE		RATE FEE
<b>BASIC FEE</b>			<b>\$375</b>		<b>\$ 750</b>
Total Claims	12-20=	-0-	x9=	or	x18= -0-
Indep claims	2 -3=	-0-	X42= -0-	or	x84= -0-
[ ] Multiple	Dep claims	-0-	+140= -0-	or	+280= -0-
			<b>TOTAL</b>		<b>TOTAL \$ 750</b>

Check in the amount of \$ 750 (for the initial filing fee) is enclosed.

The Commissioner is hereby authorized to charge \$ to Deposit Account No. 20-1424 for the filing fee listed above.

The Commissioner is hereby authorized to charge \$ to the credit card identified in the attached Credit Card Payment Form for the filing fee listed above.

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 20-1424. A duplicate copy of this sheet is attached.

Any additional fees under 37 CFR 1.16 for the presentation of extra claims.

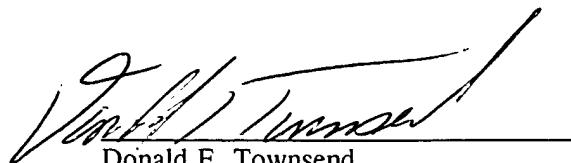
Any patent application processing fees under 37 CFR 1.17.

The Commissioner is hereby authorized to charge payment of the following fees during the pendency of this application or credit any overpayment to Deposit Account No. 20-1424. A duplicate copy of this sheet is attached.

Any patent application processing fees under 37 CFR 1.17, including extension of time fees.

Any filing fees under 37 CFR 1.16 for the presentation of extra claims.

Respectfully submitted,



Donald E. Townsend  
Reg. No. 22,069

Date: July 31, 2003

LAW OFFICES OF TOWNSEND & BANTA  
Suite 900, South Building  
601 Pennsylvania Ave., N.W.  
Washington, D.C. 20004  
(202) 220-3124